CONSTRUCTION

Solder

For many years leaded solder was the most common type of solder used by the electronics industry, but it is now being replaced by lead-free solder for health reasons. This kit contains lead-free solder, which contains 99.3% tin, 0.7% copper, and has a rosin-flux core.

Lead-free solder is different from lead solder: It has a higher melting point than lead solder, so you need higher temperature for the solder to flow properly. Recommended tip temperature is approximately 700°F; higher temperatures improve solder flow but accelerate tip decay. An increase in soldering time may be required to achieve good results. Soldering iron tips wear out faster since lead-free solders are more corrosive and the higher soldering temperatures accelerate corrosion, so proper tip care is important. The solder joint finish will look slightly duller with lead-free solders.

Use these procedures to increase the life of your soldering iron tip when using lead-free solder:

- Keep the iron tinned at all times.
- Use the correct tip size for best heat transfer. The conical tip is the most commonly used.

- Turn off iron when not in use or reduce temperature setting when using a soldering station.
- Tips should be cleaned frequently to remove oxidation before it becomes impossible to remove. Use Dry Tip Cleaner (Elenco® #SH-1025) or Tip Cleaner (Elenco® #TTC1). If you use a sponge to clean your tip, then use distilled water (tap water has impurities that accelerate corrosion).

Safety Procedures

- **Always wear safety glasses or safety goggles to protect your eyes when working with tools or soldering iron, and during all phases of testing.**
- Be sure there is **adequate ventilation** when soldering.
- Locate soldering iron in an area where you do not have to go around it or reach over it. Keep it in a safe area away from the reach of children.
- **Do not hold solder in your mouth.** Solder is a toxic substance. Wash hands thoroughly after handling solder.

Assemble Components

In all of the following assembly steps, the components must be installed on the top side of the PC board unless otherwise indicated. The top legend shows where each component goes. The leads pass through the corresponding holes in the board and are soldered on the foil side. **Use only rosin core solder.**

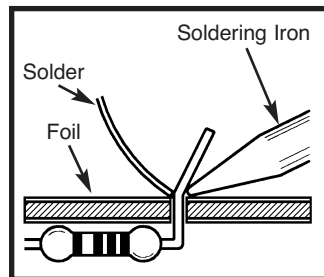**DO NOT USE ACID CORE SOLDER!**

What Good Soldering Looks Like

A good solder connection should be bright, shiny, smooth, and uniformly flowed over all surfaces.
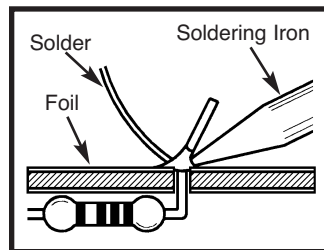
1. Solder all components from the copper foil side only. Push the soldering iron tip against both the lead and the circuit board foil.
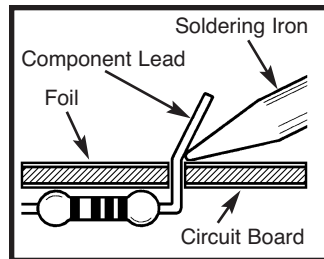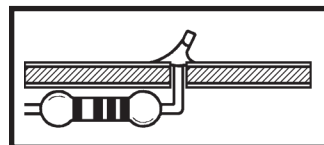

2. Apply a small amount of solder to the iron tip. This allows the heat to leave the iron and onto the foil. Immediately apply solder to the opposite side of the connection, away from the iron. Allow the heated component and the circuit foil to melt the solder.

3. Allow the solder to flow around the connection. Then, remove the solder and the iron and let the connection cool. The solder should have flowed smoothly and not lump around the wire lead.
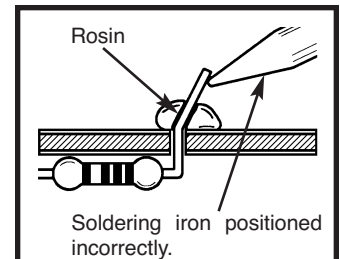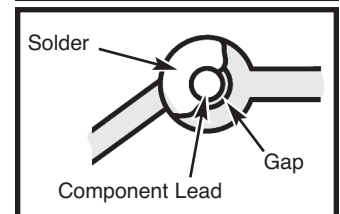

4. Here is what a good solder connection looks like.

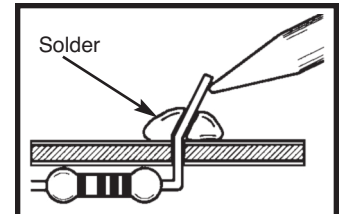

Types of Poor Soldering Connections

1. **Insufficient heat** - the solder will not flow onto the lead as shown.

2. **Insufficient solder** - let the solder flow over the connection until it is covered. Use just enough solder to cover the connection.

3. **Excessive solder** - could make connections that you did not intend to between adjacent foil areas or terminals.

4. **Solder bridges** - occur when solder runs between circuit paths and creates a short circuit. This is usually caused by using too much solder. To correct this, simply drag your soldering iron across the solder bridge as shown.